

Electronic Acknowledgement Receipt

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Application Number:	10596114
Confirmation Number:	2228
Title of Invention:	RESIN COMPOSITION, MOLDED PRODUCT FROM RESIN COMPOSITION AND METHOD FOR PREPARING RESIN COMPOSITION
First Named Inventor:	Takeshi Horie
Customer Number:	26263
Filer:	David Richard Metzger/Barbara Hannon
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Application Type:	U.S. National Stage under 35 USC 371
International Application Number:	PCT/JP04/17728

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Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
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1		Sony_6708_Spec.pdf	334910	yes	110
	Multipart Description				
	Doc Desc		Start	End	
	Specification		1	102	
	Claims		103	109	
	Abstract		110	110	
Warnings:					
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2	Documents submitted with 371 Applications	Sony_6708_PCT_Req.pdf	155499	no	6
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3	NPL Documents	Sony_6708_IDS_ISR.PDF	77571	no	2
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4	Oath or Declaration filed	Sony_6708_Dec.pdf	192338	no	4
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5	Foreign Reference	Sony_6708_IDS_Ref1.pdf	873971	no	16
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6	Foreign Reference	Sony_6708_IDS_Ref2.pdf	906080	no	16
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8	Foreign Reference	Sony_6708_IDS_Ref4.pdf	296257	no	8
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Information:					
9	Foreign Reference	Sony_6708_IDS_Ref5.pdf	939826	no	16
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Information:					
10	Foreign Reference	Sony_6708_IDS_Ref6.pdf	598281	no	11
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11	Information Disclosure Statement (IDS) Filed	Sony_6708_US_IDS_Form_SB_08a.pdf	870628	no	4
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National Stage of an International Application under 35 U.S.C. 371

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